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Low Voltage Quad Buffer with 5 V Tolerant Inputs and Outputs

74LCX125

Description

The LCX125 contains four independent non-inverting buffers with 3–STATE outputs. The inputs tolerate Voltages up to 7 V Allowing the interface of 5 V Systems to 3 V Systems.

The 74LCX125 is fabricated with an advanced CMOS technology to achieve high Speed operation while Maintaining CMOS Low Power Dissipation.

Features

- 5 V Tolerant Inputs and Outputs
- 2.3 V–3.6 V V_{CC} Specifications Provided
- 6.0 ns t_{PD} max. (V_{CC} = 3.3 V), 10 μ A I_{CC} max.
- Power Down High Impedance Inputs and Outputs
- Supports Live Insertion/Withdrawal*
- ± 24 mA Output Drive (V_{CC} = 3.0 V)
- Latch-up Performance Exceeds JEDEC 78 Conditions
- ESD Performance:
 - Human body model > 2000 V
 - ♦ Machine model > 100 V
- Leadless DQFN Package

*To ensure the High–Impedance State During Power up or down, $\overline{\text{OE}}$ Should be tied to V_{CC} through a pull–up resistor: the minimum value of the resistor is determined by the current–sourcing capability of the driver.

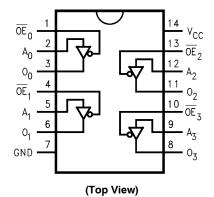


ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

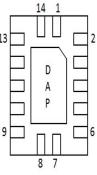
Connection Diagrams

Pin Assignments for SOIC, SOP, and TSSOP



Pad Assignments for DQFN

$\overline{\text{OE}}_0 V_{CC}$ 1 [14] 13 (13 OE₂ A₀ 2 003 (12 A₂ $\overline{OE}_1(4)$ (11 02 A1 5 $(10 \overline{OE}_3)$ 0_{16} (9 A₃ 9 8 GND O3



(Top Through View)

(Bottom View)

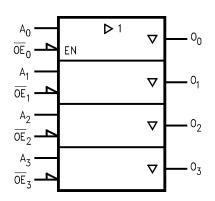
Pin Description

Pin Names	Description
A _n	Inputs
ΟEn	Output Enable Inputs
On	Outputs
DAP	No Connect
Note: DAP (Die Attac	h Pad)

Note: DAP (Die Attach Pad)

Logic Symbol

IEEE/IEC



Truth Table

Inp	Output	
<u>OE</u> n	A _n	O _n
L	L	L
L	Н	Н
Н	х	Z

H = HIGH Voltage Level

L = HIGH Voltage Level

Z = HIGH Impedance

X = Immaterial

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Ratings	Unit
V _{CC}	Supply Voltage	–0.5 to +7.0	V
VI	DC Input Voltage	–0.5 to +7.0	V
V _O	DC Output Voltage, – Output in 3–STATE – Output in HIGH or LOW State (Note 1)	–0.5 V to +7.0 –0.5 V to V _{CC} + 0.5	V V
Ι _{ΙΚ}	DC Input Diode Current, VI < GND	-50	mA
Ι _{ΟΚ}	DC Input Diode Current – VO < GND – VO > V _{CC}	-50 +50	mA mA
Ι _Ο	DC Output Source/Sink Current	±50	mA
I _{CC}	DC Supply Current per Supply Pin	±50	mA
I _{GND}	DC Ground Current per Ground Pin	±100	mA
T _{STG}	Storage Temperature	-65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. I_O Absolute Maximum Rating must be observed.

RECOMMENDED OPERATING CONDITIONS (Note 4)

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply Voltage – Operating – Data Retention	2.0 1.5	3.6 3.6	V
VI	Input Voltage	0	5.5	V
V _O	Output Voltage - HIGH or LOW State - 3-STATE	0 0	V _{CC} 5.5	V
I _{OH} / I _{OL}	$\begin{array}{l} \mbox{Common-mode Input Voltage} \\ - \mbox{V}_{CC} = 3.0 \ \mbox{V} - 3.6 \ \mbox{V} \\ - \mbox{V}_{CC} = 2.7 \ \mbox{V} - 3.0 \ \mbox{V} \\ - \ \mbox{V}_{CC} = 2.3 \ \mbox{V} - 2.7 \ \mbox{V} \end{array}$		±24 ±12 ±8	mA
T _A	Free-Air Operating Temperature	-40	85	°C
Δt / ΔV	Input Edge Rate, V _{IN} = 0.8 V $-$ 2.0 V, V _{CC} = 3.0 V	0	10	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.2. Unused inputs must be held HIGH or LOW. They may not float..

DC ELECTRICAL CHARACTERISTICS

				$T_A = -40^{\circ}C$ to $+85^{\circ}C$		
Symbol	Parameter	V _{CC} (V)	Test Conditions	Min.	Max.	Unit
V _{IH}	HIGH Level Input Voltage	2.3–2.7		1.7		V
		2.7–3.6		2.0		
V _{IL}	LOW Level Input Voltage	2.3–2.7		_	0.7	V
		2.7–3.6		_	0.8	
V _{OH}	HIGH Level Output Voltage	2.3–3.6	I _{OH} = -100 μA	V _{CC} -0.2	-	V
		2.3	I _{OH} = -8 mA	1.8	-	
		2.7	I _{OH} = -12 mA	2.2	-	
		3.0	I _{OH} = -18mA	2.4	-	
			I _{OH} = -24 mA	2.2	-	

DC ELECTRICAL CHARACTERISTICS (continued)

				T _A = −40°C to +85°C		
Symbol	Parameter	V _{CC} (V)	Test Conditions	Min.	Max.	Unit
V _{OL}	LOW Level Output Voltage	2.3–3.6	I _{OL} = 100 μA	_	0.2	V
		2.3	I _{OL} = 8 mA	_	0.6	
		2.7	I _{OL} = 12 mA	-	0.4	
		3.0	I _{OL} = 16 mA	_	0.4	
			I _{OL} = 24 mA	-	0.55	
lı	Input Leakage Current	2.3–3.6	$0 \le V_I \le 5.5 V$	_	±5.0	μA
I _{OZ}	3-STATE Output Leakage	2.3–3.6	$\begin{array}{l} 0 \leq V_O \leq 5.5 \text{ V}, \\ V_I = V_{IH} \text{ or VIL} \end{array}$	-	±5.0	μΑ
IO _{FF}	Power-Off Leakage Current	0	V_{I} or $V_{O} = 5.5 V$	_	10	μΑ
I _{CC}	Quiescent Supply Current	2.3–3.6	$VI = V_{CC}$ or GND	-	10	μA
			$3.6 V \le V_I, V_O \le 5.5 V$ (Note 3)	-	±10	
ΔI_{CC}	Increase in I _{CC} per Input	2.3–3.6	$V_{IH} = V_{CC} - 0.6 V$	-	500	μΑ

3. Outputs disabled or 3–STATE only.

AC ELECTRICAL CHARACTERISTICS

			TA = -40°C to +85°C, R _L = 500 Ω					
		V_{CC} = 3.3 V \pm 0.3 V, C_L = 50 pF		V _{CC} = C _L =		V _{CC} = 2.5 C _L = 5	V ± 0.2 V, 30 pF	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
$t_{\text{PHL}}, t_{\text{PLH}}$	Propagation Delay	1.5	6.0	1.5	6.5	1.5	7.2	ns
t _{PZL} , t _{PZH}	Output Enable Time	1.5	7.0	1.5	8.0	1.5	9.1	ns
t _{PLZ} , t _{PHZ}	Output Disable Time	1.5	6.0	1.5	7.0	1.5	7.2	ns
$t_{\rm OSHL},t_{\rm OSLH}$	Output to Output Skew (Note 4)	-	1.0	-	-	-	-	ns

4. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

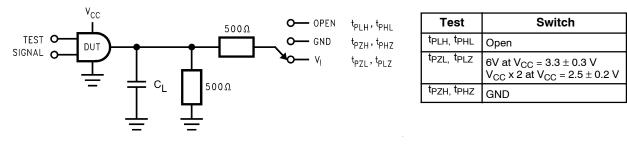
DYNAMIC SWITCHING CHARACTERISTICS

				T _A = 25°C	
Symbol	Parameter	V _{CC} (V)	Test Conditions	Typical	Unit
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	3.3	C_L = 50 pF, V_{IH} = 3.3 V, V_{IL} = 0 V	0.8	V
		2.5	C_L = 30 pF, V_{IH} = 2.5 V, V_{IL} = 0 V	0.6	
V _{OLV}	Quiet Output Dynamic Peak V _{OL}	3.3	C_L = 50 pF, V_{IH} = 3.3 V, V_{IL} = 0 V	-0.8	V
		2.5	$C_L = 30 \text{ pF}, \text{ V}_{IH} = 2.5 \text{ V}, \text{ V}_{IL} = 0 \text{ V}$	-0.6	

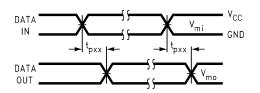
CAPACITANCE

Symbol	Parameter	Test Conditions	Typical	Unit
C _{IN}	Input Capacitance	V_{CC} = Open, V_I = 0 V or V_{CC}	7.0	pF
C _{OUT}	Output Capacitance	V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	8.0	pF
C _{PD}	Power Dissipation Capacitance	V_{CC} = 3.3 V, V_{I} = 0 V or $V_{CC,}f$ = 10 MHz	25.0	pF

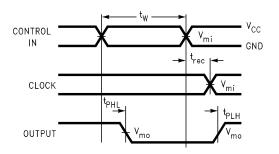
AC LOADING AND WAVEFORMS (GENERIC FOR LCX FAMILY)



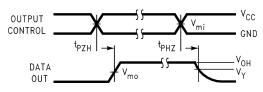


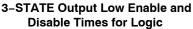


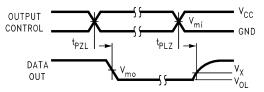
Waveform for Inverting and Non-Inverting Functions



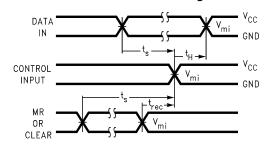
Propagation Delay. Pulse Width and trec Waveforms



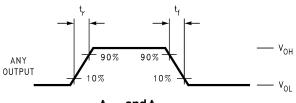




3-STATE Output High Enable and Disable Times for Logic



Setup Time, Hold Time and Recovery Time for Logic

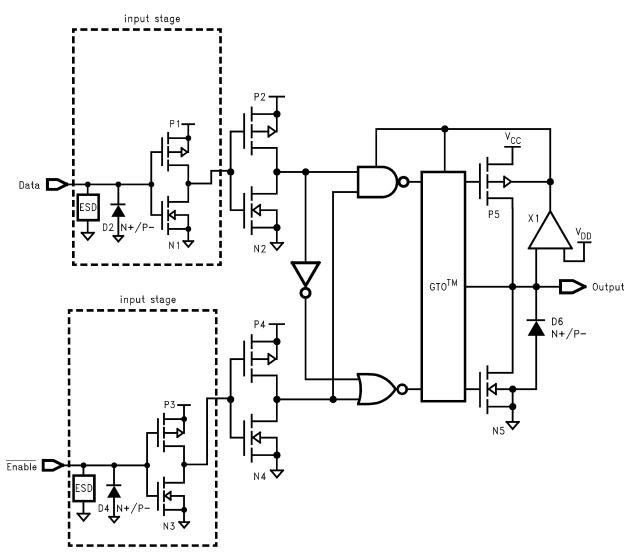


 t_{rise} and t_{fall}

	V _{CC}			
Symbol	3.3 V + 0.3 V	2.7 V	2.5 V + 0.2 V	
V _{mi}	1.5 V	1.5 V	$V_{CC}/2$	
V _{mo}	1.5 V	1.5 V	V _{CC} /2	
V _x	V _{OL} + 0.3 V	V _{OL} + 0.3 V	V _{OL} + 0.15 V	
V _y	V _{OH} – 0.3 V	V _{OH} – 0.3 V	V _{OH} – 0.15 V	

Figure 2. Waveforms (Input Characteristics; f = 1 MHz, $t_r = t_f = 3 \text{ ns}$)

SCHEMATIC DIAGRAM (GENERIC FOR LCX FAMILY)





ORDERING INFORMATION

Product Number	Package	Shipping [†]
74LCX125M	SOIC-14 (Pb-Free/Halide Free)	1150 Units / Tube
74LCX125MX	SOIC-14 (Pb-Free/Halide Free)	2500 / Tape and Reel
74LCX125MTCX	TSSOP-14 WB (Pb-Free/Halide Free)	2500 / Tape and Reel
74LCX125BQX (Note 5)	QFN-14 (Pb-Free/Halide Free)	3000 / Tape and Reel
74LCX125MTC	TSSOP-14 WB (Pb-Free/Halide Free)	2350 Units / Tube

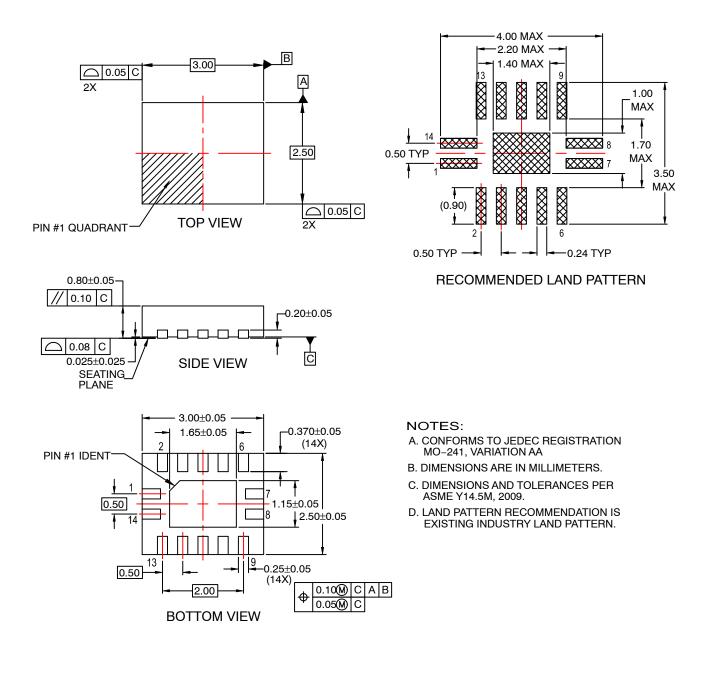
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

5. DQFN package available in Tape and Reel only.



QFN14 3.0x2.5, 0.5P CASE 510CB ISSUE O

DATE 31 AUG 2016



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SOIC14 CASE 751EF **ISSUE O** DATE 30 SEP 2016 8.75 8.50 Α 0.65 7.62 14 8 14 8 В 4.00 6.00 5.60 3.80 Ħ 1.70 7 **PIN #1** 1,27 7 0.51 **IDENT.** 1.270.35 (0.33) \oplus 0.25 (M) С В Α LAND PATTERN RECOMMENDATION TOP VIEW 1.75 MAX 0.25 С 0.19 0.10 С 1.50 0.25 0.10 1.25 SIDE VIEW **FRONT VIEW** NOTES: A. CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C **B. ALL DIMENSIONS ARE IN MILLIMETERS** 0.50 0.25 × 45° C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS LAND PATTERN STANDARD: R0.10 GAGE D. SOIC127P600X145-14M PLANE R0.10 E. CONFORMS TO ASME Y14.5M, 2009 0.36 8° 0° 0.90 0.50 SEATING PLANE (1.04)DETAIL A SCALE 16 : 1 Electronic versions are uncontrolled except when accessed directly from the Document Repository. DOCUMENT NUMBER: 98AON13739G Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SOIC14 PAGE 1 OF 1

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